LA-UR -81-525

CONF-810314-12

TITLE: DESIGN OF A POWER AMPLIFIER FOR THE LAMPF PROTON STORAGE RING
TRANSVERSE DAMPER SYSTEM

MASTER

AUTHOR(S): James S. Lunsford

SUBMITTED TO: Particle Accelerator Conference
Washington, DC March 11-13, 1981

DISCLAIMER

By acceptance of this article, the publisher recognizes that the U.S. Government retains a nonexclusive, royalty-free license to publish or reproduce the published form of this contribution, or to allow others to do so, for U.S. Government purposes.

The Los Alamos Scientific Laboratory requests that the publisher identify this article as work performed under the auspices of the U.S. Department of Energy.

University of California

LOS ALAMOS SCIENTIFIC LABORATORY

Post Office Box 1663 Los Alamos, New Mexico 87545

An Affirmative Action/Equal Opportunity Employer

DESIGN OF A POWER AMPLIFIER FOR THE LAMPF PROTON STORAGE RING TRANSVERSE DAMPER SYSTEM*

James S. Lunsford
Los Alamos National Laboratory, Los Alamos, NM 87545

Summary

A power amplifier has been designed to drive the 50- μ stripline deflection structures in the transverse active damper of the Los Alamos 800-MeV Proton Storage Ring (PSR). The unit will provide 600-V peak-to-peak with a dc-to-100-MHz bandwidth. Other important characteristics include ≤ 40 -ns delay time, 50-dB voltage gain, and 4-ns risetime with $\leq 5\%$ overshoot and ringing. Because of the current-drive properties of the amplifier, two amplifiers could be combined to provide over 1000-V peak-to-peak into 50 Ω , with very little bandwidth degradation. Components in the power amplifier that represent new designs are a 20-tube distributed-amplifier output stage; a driver stage, using VMOS FET and bipolar transistors; a high-voltage probe, with good dc stability and 150-MHz bandwidth; a transient suppressor circuit, using PIN diodes to protect the transistorized drivers from tube arcing; a nonlinear amplifier to compensate for the nonlinear characteristics of the distributed amplifier; and a first-fail indicator circuit to aid in locating the prime causes of equipment failures.

Introduction

Implementation of the transverse active-damper system for the PSR will require four power amplifiers, two for each axis, to drive the stripline deflection structures. To satisfy the anticipated damper-system requirements, each amplifier will have to meet the following specifications:

Bandwidth (3 db)	20 kHz to 100 MHz
Risetime	4 ns with $\geq 5\%$ overshoot and ringing
Output capability	1000 V peak-to-peak into 50 Ω
Transit time	≥ 100 ns
Operating mode	Class A
Power gain	50 db

Other important requirements are operation safety for personnel, high reliability, equipment protection, easy maintenance, and short repair downtime. This paper describes a prototype power-amplifier design that meets most of the design requirements outlined above.

The amplifier design described has the following characteristics:

Bandwidth	dc to 100 MHz
Risetime	4 ns with $\leq 5\%$ overshoot and ringing
Output capability	600 V peak-to-peak into 50 Ω
Delay	≤ 40 ns
Operating mode	Class A
Power gain	50 db

Although a single amplifier module does not meet the full output capability nor the power gain requirements listed for the final design, two such amplifiers can be combined to meet these requirements with only a slight modification to bandwidth and risetime properties. Several new circuit designs were necessary to produce the prototype power amplifier shown in the block diagram of Fig. 1.

Fig. 1. Power amplifier simplified block diagram.

Distributed Amplifier

The high-power, wide-bandwidth output capability is provided by a 20-tube distributed amplifier using water-cooled RCA 4636 tetrodes that were designed specifically for distributed-amplifier¹ use. This circuit is made of ten sections, each section using two tetrodes with their plates paralleled (Fig. 2). The plate and grid lumped-transmission lines use negative mutual-inductance for linear phase, wide bandwidth, and parasitic tube inductance compensation. The RLC circuits labeled X_p and X_g in Fig. 2 reduce the high-frequency ringing with very little effect on risetime. This ringing is reduced even further, at the expense of increased risetime, by delaying the grid drive signal to one pair of grid lines. The optimum delay for greatest ringing reduction is one-half the ringing-frequency period. Figure 2 shows a waveform obtained when using these ringing-reduction techniques. To obtain maximum output capability from the distributed amplifier, it is necessary to select the screen voltage for each tube because the RCA 4636 tetrodes have considerable tube-to-tube variation. These voltages are obtained from a Zener-diode string, powered by the plate supply. To protect the tetrodes from destructive arcs, a 20-ns SCR circuit is used to crowbar the screen voltages when an arc is detected. The plate supply is also fast crowbarred, but with a 10- μ s SCR.

Drivers

Generally in the past, it has been necessary to use a second distributed amplifier to drive wideband distributed-amplifier output stages. Transistorized

*Work performed under the auspices of US Department of Energy.

Fig. 2. Distributed-amplifier simplified schematic and pulse response.

5 ns/div

circuits have not been available that could provide the necessary bandwidth and power combinations required. In the transverse-damper power amplifier, use of a distributed-amplifier driver would be marginal, because of the long delays inherent in such drivers. Fortunately, VMOS FET transistors now are available that can provide the bandwidth and power required to drive the RCA 4636 tubes. A driver design using VMOS FET and microwave bipolar transistors is shown in Fig. 3. This circuit has a dc-to-150-MHz bandwidth, a 2.5-ns risetime, a voltage gain of 30, and a drive capability of 30 V p-p into 25 Ω. The VMOS FET requires a low-impedance (12.5 Ω) drive because of its high input capacitance (~50 pF). To maintain good dc stability, a dc stabilization loop (U1 in Fig. 3) is used.

Transient Suppressor

When a transistor circuit is used to drive a high-power tube-type amplifier, there is the possibility of damage to the transistors if a tube arcs. To prevent that occurrence, a circuit has been designed to protect the transistorized drivers. This circuit consists of back-biased PIN diodes arranged in a 50-Ω lumped transmission line configuration (Fig. 4). The diode capacitance is ~0.4 pF and the resulting upper frequency limit for normal signals is >500 MHz. Transient voltages exceeding the -bias or +bias voltages are clipped by the PIN diodes.

Fig. 3. Grid-driver simplified schematic and pulse response.

Nonlinear Amplifier

The distributed amplifier has significant nonlinearity for large signals. If uncompensated, this nonlinearity will result in nonsymmetrical signal amplitudes driving the stripline deflection structures. These nonsymmetrical signals would result in increased reflections and standing waves, because of the odd-even coupling effects of the stripline deflectors. To compensate for the distributed-amplifier's nonlinearity, a nonlinear low-level circuit, using the temperature-stable characteristics of a tunnel diode, has been designed. A tunnel-diode network (TD, R1, and R2 in Fig. 5) is driven by a current source, T1 and T2, and the resulting voltage is amplified by a voltage amplifier, T3 and T4. The current source and voltage amplifier are dc stabilized with low-frequency feedback loops.

High-Voltage Probe

The damper system will require stable monitoring of the dc voltage on the stripline deflectors and also wideband monitoring of the deflector drive signals. Both of these requirements can be satisfied with the high-voltage probe circuit shown in Fig. 6. The probe's frequency response is dc to ~200 MHz, and the divide ratio is 500:1. The probe consists of an RC-compensated divider, a wideband unity-gain amplifier, and a dc-stabilization circuit.

5 ns/div

20 ns/div

Fig. 4. Transient-suppressor simplified schematic and pulse-limiting waveform.

2 μ s/div

Fig. 5. Nonlinear-amplifier simplified schematic and waveforms.

Fig. 6. High-voltage probe simplified schematic and pulse response.

First-Fail Circuit

To aid in locating prime causes of equipment failure, a first-fail circuit has been designed. This circuit monitors all interlock functions and indicates the first function that fails during an equipment shut-down. This should greatly reduce trouble-shooting time in many instances. The circuit uses multichannel MHL latch circuits.

Acknowledgments

I wish to express my appreciation to Ed Higgins for many useful discussions. I also want to thank the PSR electronics section technicians, particularly George Hsuwawalt, for their invaluable assistance.

References

1. E. Ginzto, W. R. Hewlett, J. H. Jasberg, J. D. Nue, "Distributed Amplification," Proc. of the IRE, 36, No. 8, pp. 956-969 (1948).